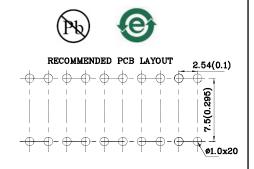


Part Number: XGCBDX10D

10 SEGMENT BAR GRAPH ARRAY

Features

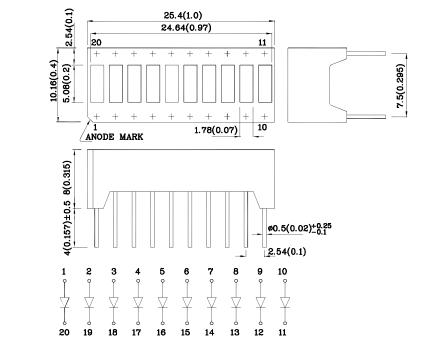
- Robust package
- ullet Uniform light disbursement
- Ideal for backlighting logos or icons
- Excellent for flush mounting
- Standard configuration: Gray face w/ white segments
- RoHS compliant





ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC

Package Schematics



Notes:

- 1. All dimensions are in millimeters (inches), Tolerance is $\pm 0.25 (0.01") unless otherwise noted.$
- 2. Specifications are subject to change without notice.

Absolute Maximum Ratings (T _A =25°C)		Blue (InGaN)	Unit	
Reverse Voltage	$V_{\rm R}$	5	V	
Forward Current	I_{F}	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	150	mA	
Power Dissipation	P_D	120	mW	
Operating Temperature	T_{A}	-40 ~ +85	°C	
Storage Temperature	Tstg	-40 ~ +85		
Electrostatic Discharge Threshold (HBM)		250	V	
Lead Solder Temperature [2mm Below Package Base]	260°C For 3-5 Seconds			

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

Operating Characteristics (T _A =25°C)		Blue (InGaN)	Unit
Forward Voltage (Typ.) (I _F =10mA)	V_{F}	3	V
Forward Voltage (Max.) (I _F =10mA)	V_{F}	4	V
Reverse Current (Max.) $(V_R=5V)$	I_R	50	uA
Wavelength of Peak Emission CIE127-2007* (Typ.) (I _F =10mA)	λΡ	460*	nm
Wavelength of Dominant Emission CIE127-2007* (Typ.) $(I_F=10\text{mA})$	λD	465*	nm
Spectral Line Full Width At Half-Maximum (Typ.) (I _F =10mA)	$\triangle \lambda$	25	nm
Capacitance (Typ.) (V _F =0V, f=1MHz)	С	100	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity CIE127-2007* $(I_F=10\text{mA}) \text{ ucd}$		Wavelength CIE127-2007* nm λP	Description
			min.	typ.		
XGCBDX10D	Blue	InGaN	3600*	9390*	460*	10 Segments Bar graph-Display

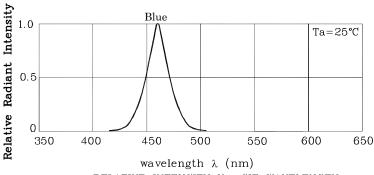
^{*}Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

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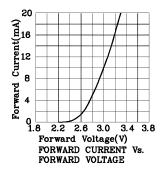


10 SEGMENT BAR GRAPH ARRAY

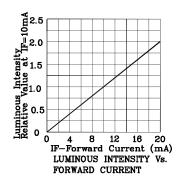


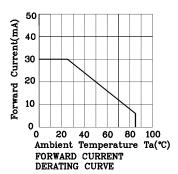
RELATIVE INTENSITY Vs. CIE WAVELENGTH

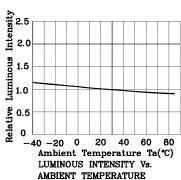
❖ Blue



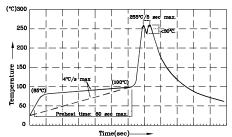
www.SunLEDusa.com







Wave Soldering Profile for Thru-Hole Products (Pb-Free Components)



- Notes: 1. Recommend pre-heat temperature of 105°C or less (as m thermocouple attached to the LED pins) prior to immersis wave with a maximum solder bath temperature of 260°C 2. Peak wave soldering temperature between 245°C \sim 255°C $^{\prime\prime}$
- max).
 3.Do not apply stress to the epoxy resin while the temperature is a
 4.Fixtures should not incur stress on the component when mounting
 during soldering process.
 5.SAC 305 solder alloy is recommended.
 6.No more than one wave soldering pass.
 7.During wave soldering, the PCB top-surface temperature should be
 kept below 105°C.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity / luminous flux, or wavelength),

the typical accuracy of the sorting process is as follows:

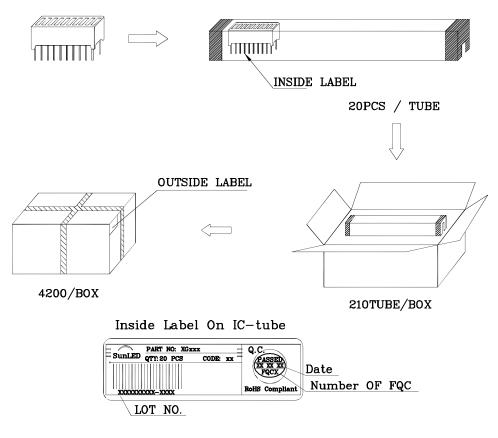
- 1. Wavelength: +/-1nm
- 2. Luminous Intensity / Luminous Flux: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

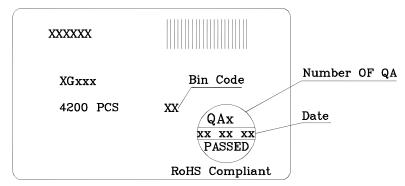




PACKING & LABEL SPECIFICATIONS



Outside Label On Box



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- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet. User accepts full risk and responsibility when operating the product(s) beyond their intended specifications.
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